Please note that this diagram is a schematic representation of the PMP20050 SchDoc. The schematic includes various components such as resistors, capacitors, and ICs, along with their values and connections. The diagram is annotated with labels for each component, indicating their function and placement on the board.

The schematic also includes comments and notes, which are essential for understanding the design and functionality of the PMP20050. These comments provide additional information about the design, such as the purpose of certain components, the recommended operating conditions, and any special considerations for the user.

The schematic is a valuable resource for anyone working with the PMP20050, as it provides a visual representation of the design and helps in understanding the interconnections and functionality of its various parts. It is recommended that users refer to the schematic regularly to ensure that they have a clear understanding of the design and can make informed decisions about its implementation.
You should delete the nylon screws/standoffs and/or the bumpers as needed for your design (or substitute other parts from Hardware.IntLib). Bumpers are cheaper, but provide less clearance.

Deleting anything else from this page may result in your EVM submission being rejected (until you add them back).

Update the Label Text in the Label Table as needed for each Assembly Variant:

You can delete this note too.
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